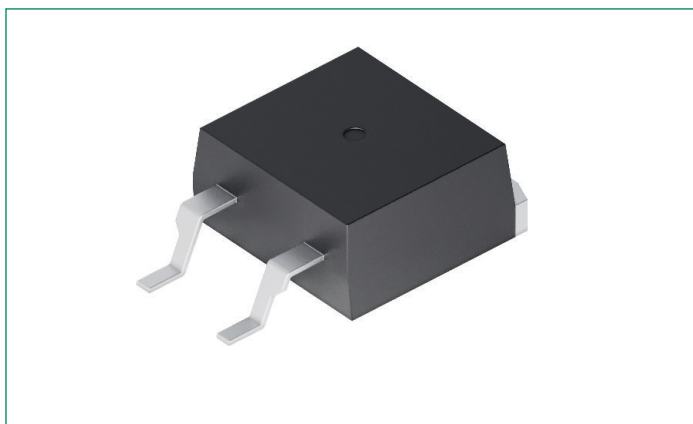


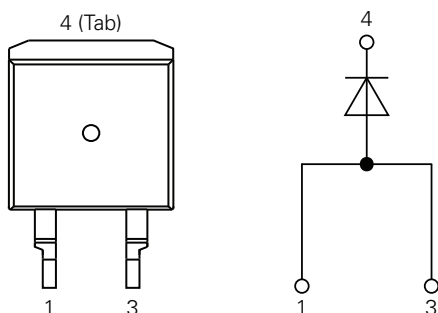
# DMA30IM1600PZ

## 1600 V, 30 A Standard Rectifier

RoHS



### Pinout Diagram TO-263 (D<sup>2</sup>PAK-HV)



**1:** Anode; **3:** Anode ; **4:** Cathode

### Description

This 1600 V, 30 A high-performance, standard single diode provides a simplified system design packaged in TO-263 2-lead HV.

This device belongs to the rectifier diode series, featuring planar passivated chips and low leakage current. These features make it suitable for reliable rectification in applications such as power supplies and battery chargers.

Littelfuse rectifier diodes can be integrated with other power semiconductors to provide complete power solutions for a wide range of applications.

### Features

- Planar passivated chips
- Low leakage current of 40  $\mu$ A
- Low  $V_F$  of 1.26 V
- Improved thermal behavior

### Applications

- Uninterruptible power supply
- Power supplies
- Battery chargers

### Package TO-263 (D<sup>2</sup>PAK-HV)

- Industry standard outline
- High creepage distance between terminals
- RoHS compliant
- Epoxy meets UL 94V-0

### Product Summary

Characteristic	Value	Unit
$V_{RRM}$	1600	V
$I_{F(AV)}$	30	A
$V_F$	1.26	V

## Maximum Ratings

Symbol	Characteristics	Conditions	Value	Units
$V_{RSM}$	Non-repetitive Reverse Blocking Voltage	$T_{vj} = 25\text{ }^{\circ}\text{C}$	1700	V
$V_{RRM}$	Repetitive Reverse Blocking Voltage	$T_{vj} = 25\text{ }^{\circ}\text{C}$	1600	V
$I_{F(AV)}$	Average Forward Current	$T_c = 140\text{ }^{\circ}\text{C}$ , $T_{vj} = 175\text{ }^{\circ}\text{C}$ ; rectangular $d = 0.5$	30	A
$I_{FSM}$	Forward Surge Current	$t = 10\text{ ms}$ ; (50 Hz), sine, $T_{vj} = 45\text{ }^{\circ}\text{C}$	300	A
		$t = 8.3\text{ ms}$ ; (60 Hz), sine, $V_R = 0\text{ V}$	325	
		$t = 10\text{ ms}$ ; (50 Hz), sine, $T_{vj} = 150\text{ }^{\circ}\text{C}$	255	
		$t = 8.3\text{ ms}$ ; (60 Hz), sine, $V_R = 0\text{ V}$	275	
$I^2t$	Value for fusing	$t = 10\text{ ms}$ ; (50 Hz), sine, $T_{vj} = 45\text{ }^{\circ}\text{C}$	450	A <sup>2</sup> s
		$t = 8.3\text{ ms}$ ; (60 Hz), sine, $V_R = 0\text{ V}$	440	
		$t = 10\text{ ms}$ ; (50 Hz), sine, $T_{vj} = 150\text{ }^{\circ}\text{C}$	325	
		$t = 8.3\text{ ms}$ ; (60 Hz), sine, $V_R = 0\text{ V}$	315	
$T_{stg}$	Storage Temperature Range	–	–55 to +150	$^{\circ}\text{C}$
$T_{vj}$	Virtual Junction Temperature Range	–	–55 to +175	$^{\circ}\text{C}$
$P_{tot}$	Total Power Dissipation	$T_c = 25\text{ }^{\circ}\text{C}$	210	W

## Thermal Specifications

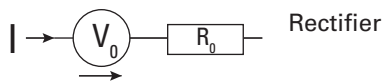
Symbol	Characteristic	Value			Units
		Min.	Typ.	Max.	
$R_{th(j-c)}$	Thermal Resistance, Junction to Case	–	–	0.7	K/W
$R_{th(c-h)}$	Thermal Resistance, Case to Heatsink	–	0.25	–	K/W

## Electrical Characteristics

Symbol	Characteristics	Conditions	Value			Units	
			Min.	Typ.	Max.		
$I_R$	Reverse Leakage Current	$T_{vj} = 25\text{ }^{\circ}\text{C}$	–	–	40	$\mu\text{A}$	
		$T_{vj} = 150\text{ }^{\circ}\text{C}$	–	–	1.5	mA	
$V_F$	Forward Voltage	$T_{vj} = 25\text{ }^{\circ}\text{C}$	$I_F = 30\text{ A}$	–	–	1.29	V
			$I_F = 60\text{ A}$	–	–	1.60	
		$T_{vj} = 150\text{ }^{\circ}\text{C}$	$I_F = 30\text{ A}$	–	–	1.26	
			$I_F = 60\text{ A}$	–	–	1.65	
$V_{FO}$	Threshold Voltage	$T_{vj} = 175\text{ }^{\circ}\text{C}$	–	–	0.82	V	
$r_F$	Slope Resistance	$T_{vj} = 175\text{ }^{\circ}\text{C}$	–	–	14.1	m $\Omega$	
$C_j$	Junction Capacitance	$V_R = 400\text{ V}$ , $f = 1\text{ MHz}$ , $T_{vj} = 25\text{ }^{\circ}\text{C}$	–	10	–	pF	

**Package** TO-263 (D<sup>3</sup>PAK-HV)

Symbol	Characteristics	Conditions	Value			Units
			Min.	Typ.	Max.	
$I_{RMS}$	RMS Current	per terminal	–	–	35	A
$T_{op}$	Operating Temperature Range	–	–55 to +150			°C
$F_C$	Mounting Force with Clip	–	20	–	60	N
G	Weight	–	–	1.5	–	g
$d_{Spp/App}$	Creepage Distance on Surface/ Striking Distance through Air	terminal to terminal	4.2	–	–	mm
$d_{Spb/Apb}$		terminal to backside	4.7	–	–	mm

**Equivalent Circuits for Simulation** ( $T_{vj} = 175\text{ °C}$ )

Symbol	Characteristics	Value	Units
$V_{0\ max}$	Threshold Voltage	0.82	V
$R_{0\ max}$	Slope Resistance <sup>1</sup>	10.9	mΩ

**Note 1:** On die level

Characteristic Curves

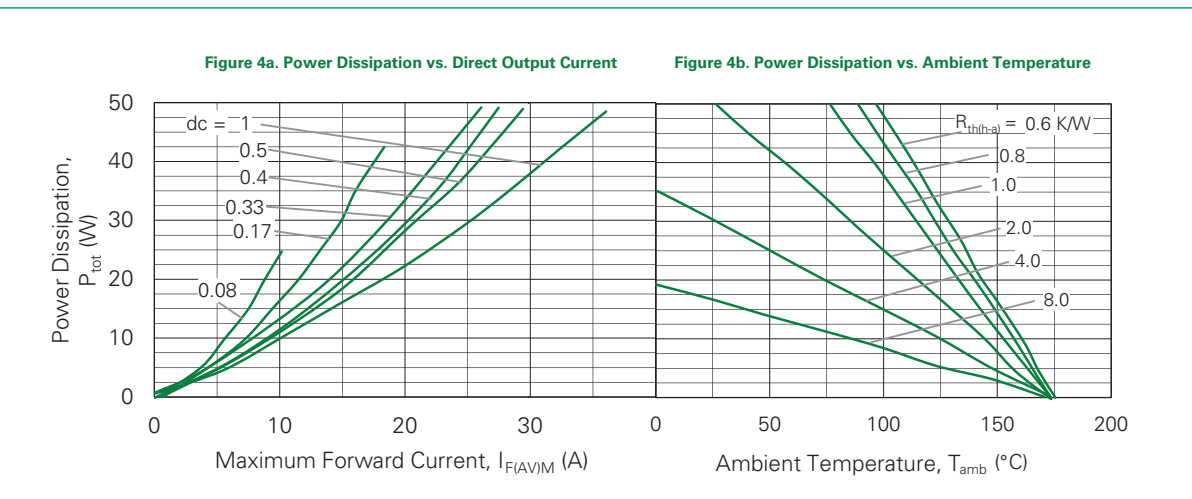
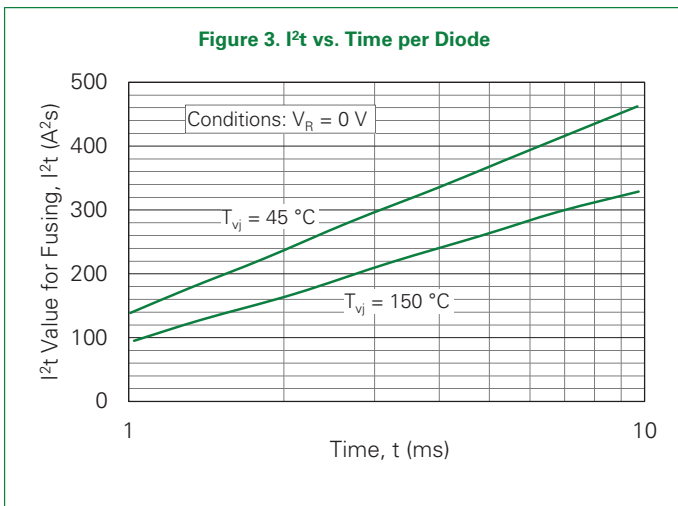
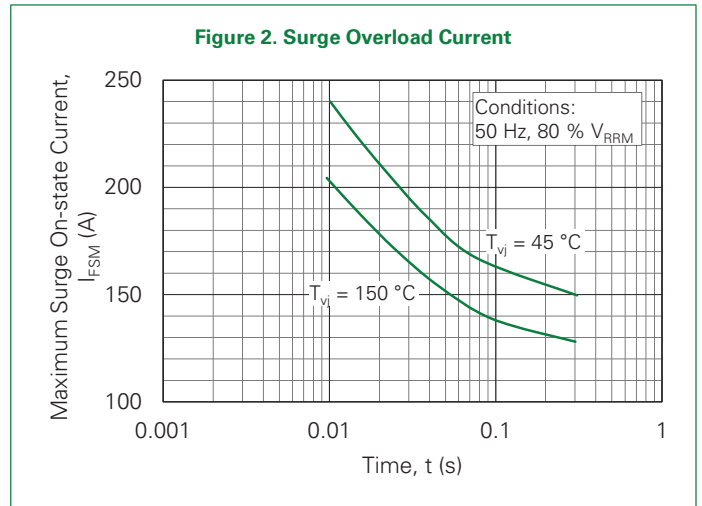
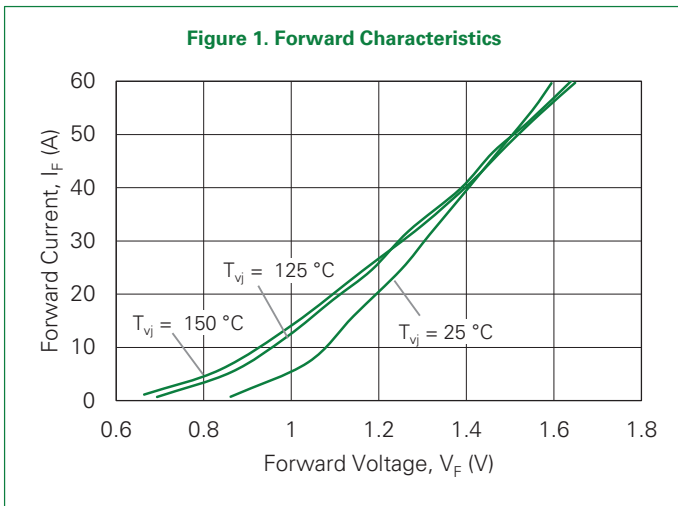


Figure 5. Maximum Forward Current vs. Case Temperature

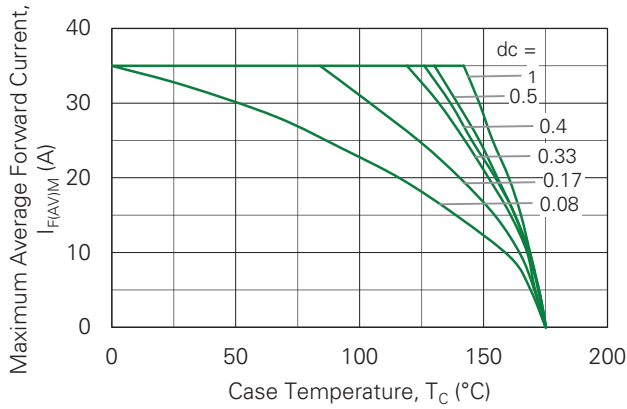
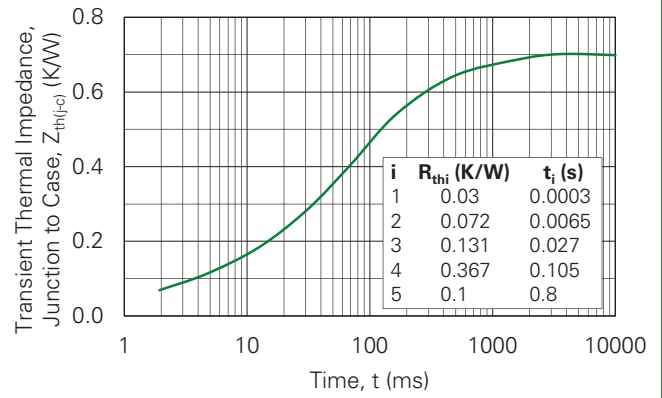
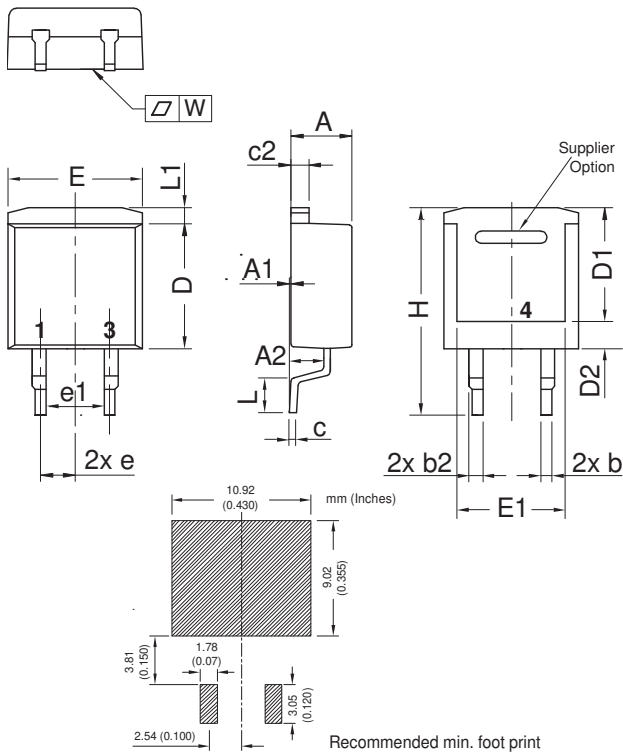


Figure 6. Transient Thermal Impedance, Junction to Case



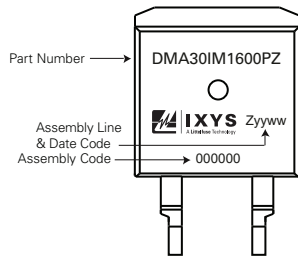
Part Outline Drawing TO-263 (D<sup>2</sup>PAK-HV)



Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max
A	4.3	4.7	0.169	0.185
A1	typ. 0.10		typ. 0.004	
A2	2.41		0.095	
b	0.51	0.99	0.020	0.039
b2	1.14	1.40	0.045	0.055
c	0.40	0.74	0.016	0.029
c2	1.14	1.40	0.045	0.055
D	8.38	9.40	0.330	0.370
D1	8.00	8.89	0.315	0.350
D2	2.3		0.091	
E	9.65	10.41	0.380	0.410
E1	6.22	8.50	0.245	0.335
e	2.54 BSC		0.100 BSC	
e1	4.28		0.169	
H	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	1.02	1.68	0.040	0.066
W	typ. 0.02	0.040	typ. 0.0008	0.002

Note: All dimensions conform with and/or within JEDEC standard.

## Part Numbering and Marking



D = Diode  
 M = Standard Rectifier  
 A = Up to 1800 V  
 30 = Current Rating (A)  
 IM = Single Diode  
 1600 = Reverse Voltage  
 PZ = TO-263AB (D<sup>2</sup>PAK) (HV)

## Packing Options

Part Number	Marking	Packing Mode	Quantity
DMA30IM1600PZ-TRL	DMA30IM1600PZ	Tape & Reel	800 pcs
DMA30IM1600PZ-TUB	DMA30IM1600PZ	Tube	50 pcs

### Disclaimer Notice

Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at <http://www.littelfuse.com/disclaimer-electronics>.



Part of:

